SMT POWER INDUCTORS Shielded Drum Core - PF0560NL Series





- Height: 4.0mm Max
- 🗣 Footprint: 10.4 x 10.4mm Max
- Current Rating: up to 6.5A
- Inductance Range: 1.5µH to 330µH
- 260°C reflow peak temperature qualified
- Leaded technology compatible

Electrical Specifications @ 25°C — Operating Temperature -40°C to +125°C ⁶								
Part ^{2,3} Number	Inductance @ 0A _D c (µH)	Inductance @ Irated (µH TYP)	Irated ⁵ (A)	DCR (mΩ MAX)	Saturation ⁶ Current Isat -35% (A)	Heating ⁷ Current lbc +30°C(A)	Core Loss ⁸ Factor (K2)	SRF (MHz)
PF0560.152NL	1.5 ±30%	1.5	6.5	8.1	10	6.5	260	>40
PF0560.252NL	2.5 ±30%	2.5	6.1	10.5	7.5	6.1	330	>40
PF0560.382NL	3.8 ±30%	3.8	5.5	13	6.0	5.5	420	39
PF0560.522NL	5.2 ±30%	5.2	5.4	22	5.5	5.4	480	34
PF0560.702NL	7.0 ±30%	7.0	4.5	27	4.8	4.5	500	29
PF0560.103NL	10 ±30%	10	3.8	35	4.4	3.8	630	25
PF0560.153NL	15 ±30%	15	3.1	50	3,6	3.1	790	19
PF0560.223NL	22 ±30%	22	2.5	73	2.9	2.5	910	17
PF0560.333NL	33 ±25%	33	2.2	93	2.3	2.2	1200	14
PF0560.473NL	47 ±25%	47	1.9	128	2.1	1.9	1300	10
PF0560.683NL	68 ±25%	68	1.42	213	1.5	1.42	1700	9.0
PF0560.104NL	100 ±25%	100	1.25	304	1.35	1.25	2000	6.6
PF0560.154NL	150 ±25%	150	0.85	506	1.15	0.85	2400	5.4
PF0560.224NL	220 ±25%	220	0.7	756	0.92	0.7	2900	5.2
PF0560.334NL	330 ±25%	330	0.52	1090	0.70	0.52	3580	3.2

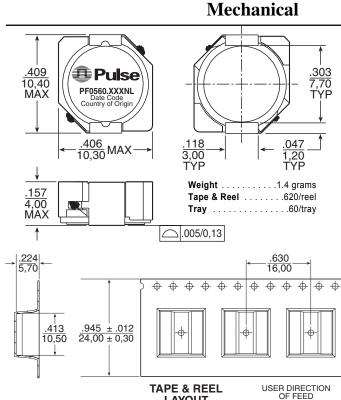
<u>.421</u> 10,70

287

7,30

<u>.138</u> 3,50

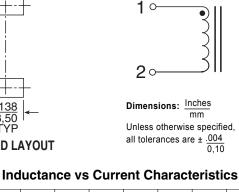
SUGGESTED PAD LAYOUT

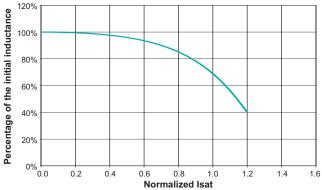


LAYOUT

NOTES FROM TABLE: (See page 43)

Schematic





USA 858 674 8100 • Germany 49 7032 7806 0 • Singapore 65 6287 8998 • Shanghai 86 21 54643211 / 2 • China 86 755 33966678 • Taiwan 886 3 4641811

SMT POWER INDUCTORS Shielded Drum Core Series



8. In high volt*time (Et) or ripple current applications, addi-

tional heating in the component can occur due to core losses in the inductor which may necessitate derating

the current in order to limit the temperature rise of the

component. In order to determine the approximate total

loss (or temperature rise) for a given application, both

copper losses and core losses should be taken into

account.

Estimated Temperature Rise:

Irms = $[IDC^2 + \Delta I^2/12]^{1/2}$ (A)

less than 2500 Gauss.

Trise = $[Total loss (mW) / K0]^{.833} (°C)$

Total loss = Copper loss + Core loss (mW)

Copper loss = IRMS² x DCR (Typical) (mW)

Core loss = K1 x f (kHz)^{1.23} x Bac(Ga)^{2.38} (mW)

Bac (peak to peak flux density) = $K2 \times \Delta I$ (Ga)

where f varies between 25kHz and 1MHz, and Bac is

K2 is a core size and winding dependant value and

is given for each p/n in the proceeding datasheets.

and are given in the table below for each platform.

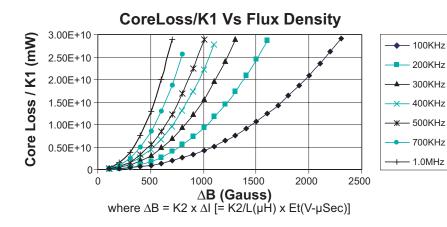
K0 & K1 are platform and material dependant constants

 $[= K2/L(\mu H) \times Et(V-\mu Sec) (Ga)]$

Notes from Tables (pages 27 - 42)

- 1. Unless otherwise specified, all testing is made at 100kHz, 0.1VAC.
- Optional Tape & Reel packaging can be ordered by adding a "T" suffix to the part number (i.e. P1166.102NL becomes P1166.102NLT). Pulse complies with industry standard Tape and Tape & Reel specification EIA481.
- 3. The "NL" suffix indicates an RoHS-compliant part number. Non-NL suffixed parts are not necessarily RoHS compliant, but are electrically and mechanically equivalent to NL versions. If a part number does not have the "NL" suffix, but an RoHS compliant version is required, please contact Pulse for availability.
- 4. Temperature of the component (ambient plus temperature rise) must be within specified operating temperature range.
- 5. The rated current (Irated) as listed is either the saturation current or the heating current depending on which value is lower.
- 6. The saturation current, Isat, is the current at which the component inductance drops by the indicated percentage (typical) at an ambient temperature of 25°C. This current is determined by placing the component in the specified ambient environment and applying a short duration pulse current (to eliminate self-heating effects) to the component.
- 7. The heating current, Idc, is the DC current required to raise the component temperature by the indicated delta (approximately). The heating current is determined by mounting the component on a typical PCB and applying current for 30 minutes. The temperature is measured by placing the thermocouple on top of the unit under test.

Part No.	Trise Factor (K0)	Core Loss Factor (K1)	
PG0085/86	2.3	5.29E-10	
PG0087	5.8	15.2E-10	
PG0040/41	0.8	2.80E-10	
P1174	0.8	6.47E-10	
PF0601	4.6	14.0E-10	
PF0464	3.6	24.7E-10	
PF0465	3.6	33.4E-10	
P1166	1.9	29.6E-10	
P1167	2.1	42.2E-10	
PF0560NL	5.5	136E-10	
P1168/69	4.8	184E-10	
P1170/71	4.3	201E-10	
P1172/73	5.6	411E-10	
PF0552NL	8.3	201E-10	
PF0553NL	7.1	411E-10	



Take note that the component's temperature rise varies depending on the system condition. It is suggested that the component be tested at the system level, to verify the temperature rise of the component during system operation.

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